

WCN4-0028B7-C21

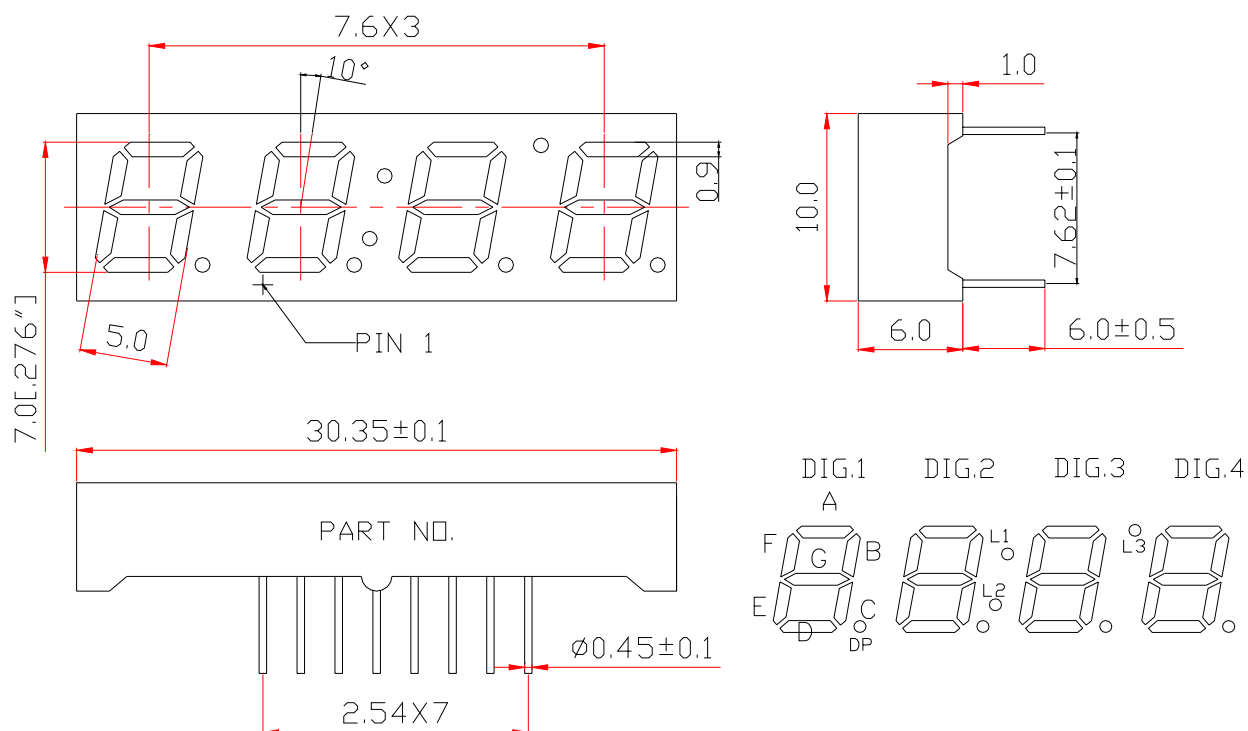
SPECIFICATION

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Fei 2016-4-1	Athena	William	
REVISION RECORD			



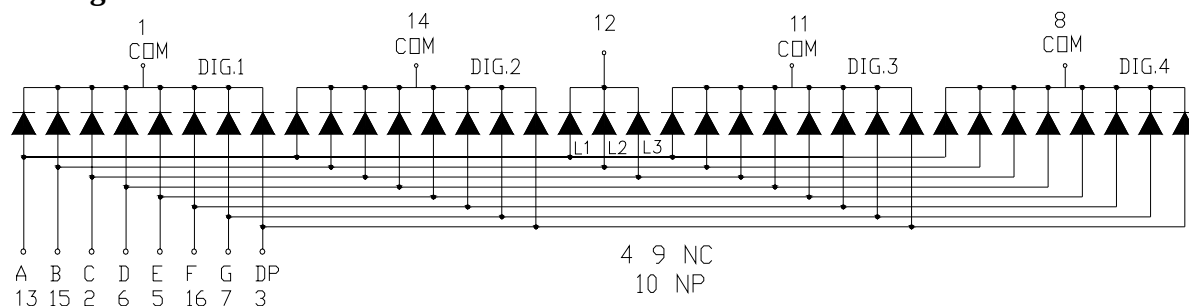
REVISION: A0

■ **Outer Dimension:**



Notes: Unless otherwise stated, The tolerance is $\pm 0.25\text{mm}$.

■ **Circuit Diagram:**



■ **Pin Connection:**

PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Common Cathode Dig1	9	NO Connected
2	Anode C	10	NO PIN.
3	Anode DP	11	Common Cathode Dig3
4	NO Connected	12	Common Cathode L1~L3
5	Anode E	13	Anode A
6	Anode D	14	Common Cathode Dig2
7	Anode G	15	Anode B
8	Common Cathode Dig4	16	Anode F

WCN Opto Group Co., Limited

■ Features:

- High Reliability
- Color: Blue
- Low Power Requirement
- Easy Assembly

■ Description:

- Four Digit Display
- Digit Height: 7.0mm(0.28")
- Black Face and Milky Segment

■ Absolute Maximum Rating (Ta=25℃):

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Segment	P _d	—	Blue	90	mW
Forward Current Per Segment	I _F	—	Blue	25	mA
Peak Forward Current Per Segment	I _{FP}	1/10 Duty 10KHz	Blue	100	mA
Reverse Voltage Per Segment	V _R	—	Blue	5	V
Operating Temperature Range	T _{opr}	—	—	-35~+85	℃
Storage Temperature Range	T _{stg}	—	—	-35~+85	℃

■ Electrical/Optical Characteristics Rating(Ta=25℃)

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V _F	I _F =20mA	Per Segment	—	3.20	3.60	V
Reverse Current	I _R	V _R =5V	Per Segment	—	—	100	μA
Luminous Intensity	I _V	I _F =10mA	Per Segment	6101	9500	15250	μcd
Peak Emission Wave Length	λ _P	I _F =20mA	Per Segment	—	—	—	nm
	λ _D			465	470	475	
Spectral Line Half Width	△λ	I _F =20mA	Per Segment	—	30	—	nm
Luminous Intensity Matching Ratio (Segment to Segment)	I _{v-m}	I _F =10mA	—	—	—	1.2:1	

■ Luminous Intensity Sorting: (Luminous Intensity Tolerance is +/-10%)

Rank	Symbol	Condition	Min	Max	Unit
N	N	I _F =10mA	6101	7200	μcd
O	O	I _F =10mA	7201	8500	μcd
P	P	I _F =10mA	8501	10500	μcd
Q	Q	I _F =10mA	10501	12800	μcd
R	R	I _F =10mA	12801	15250	μcd

■ Soldering Conditions: Soldering Temp. ≤+260℃, Soldering Time. ≤3sec.
(at 2mm Distance from The Case of Reflector Edge)

■ Typical Elector-Optical Characteristics Curve:

Fig1. Forward Current vs. Forward Voltage:

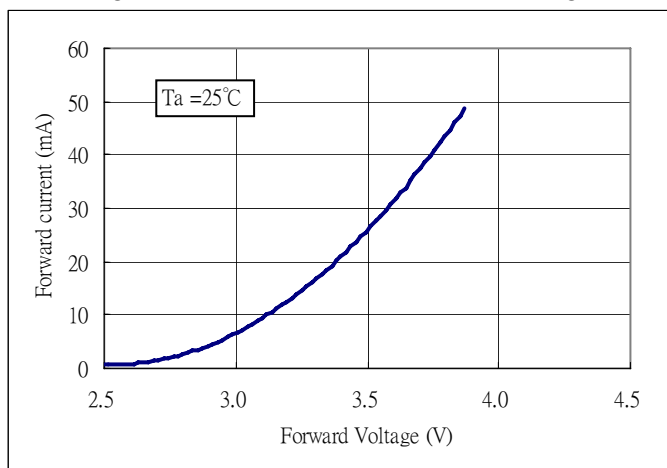


Fig2. Forward Current vs. Relative Intensity:

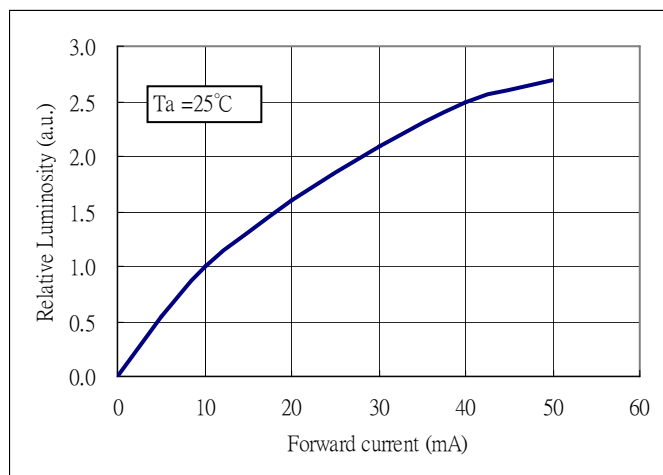


Fig3. Forward Current vs. Relative wavelength:

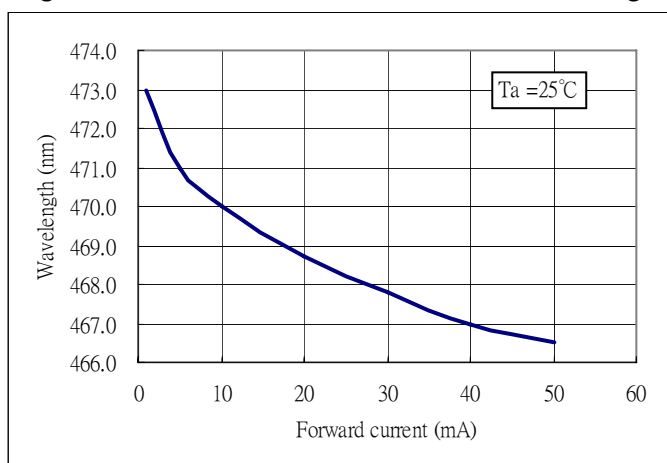
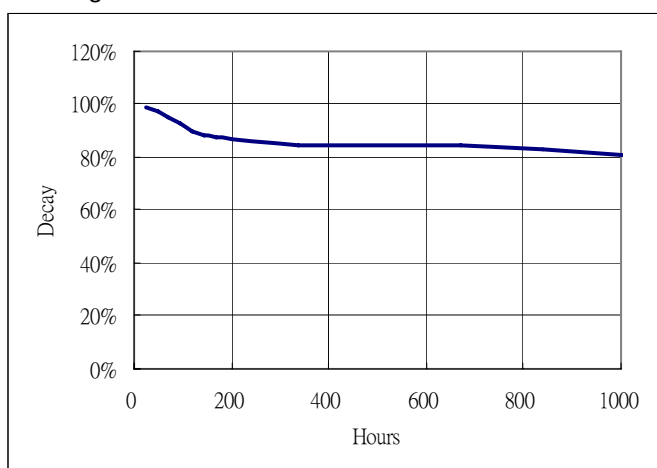


Fig4. Life Test at 20mA R.T. 1000hrs:



LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS T_a = UNDER ROOM TEMPERATURE $I_F = I_F \text{ max}$
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY $T_a = 65 \pm 5^\circ\text{C}$ RH=90~95%RH TEST TIME=240 $\pm$ 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE $T_a = 85 \pm 5^\circ\text{C}$ (COB: $T_a = 65 \pm 5^\circ\text{C}$) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE $T_a = -35 \pm 5^\circ\text{C}$ TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION 85 $^\circ\text{C}$ ~ 25 $^\circ\text{C}$ ~ -35 $^\circ\text{C}$ ~ 25 $^\circ\text{C}$ 30min 5min 30min 5min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES 85 $\pm 5^\circ\text{C}$ ~ -35 $\pm 5^\circ\text{C}$ 10min 10min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE $T_{\text{SOL}}=230 \pm 5^\circ\text{C}$ DWELL TIME=5 $\pm$ 1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING $T_{\text{SOL}}=260 \pm 5^\circ\text{C}$ DWELL TIME=10 $\pm$ 1sec.

Packing method A:

140 pcs / Red Expandable Polyethylene.

840 pcs / Box(360*175*130mm).

5040 pcs / Carton(550*380*280mm).

Packing method B:

16 pcs / IC Tube.(525*13*18.8)

1248 pcs / Box(537*175*125mm).

4992 pcs / Carton(550*380*280mm).